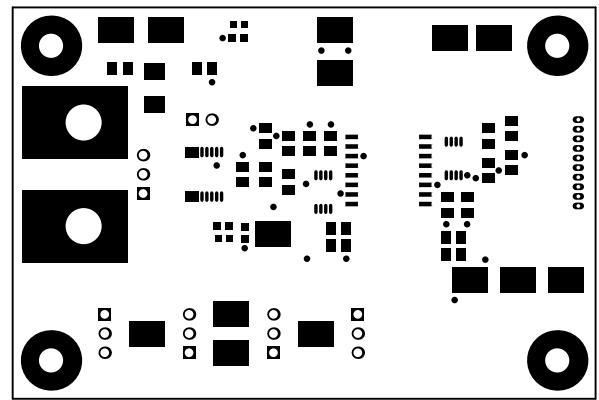
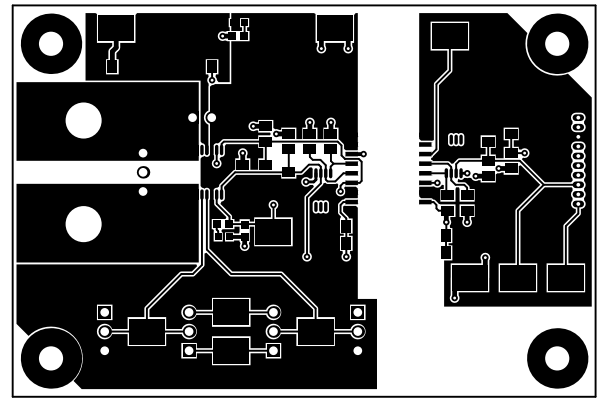


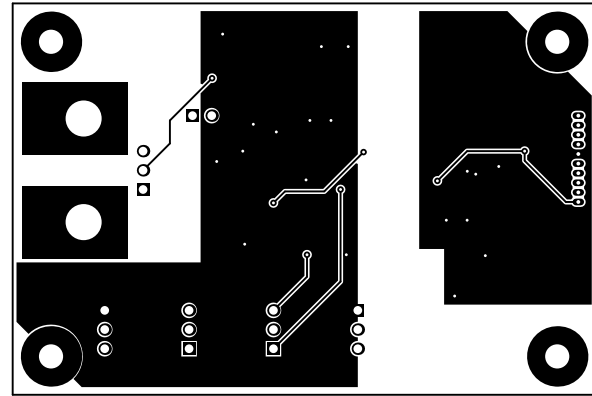
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01608	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01608		
PLOT NAME = Top Overlay	GENERATED : 12/15/2017 11:39:56 AM	TEXAS INSTRUMENTS	



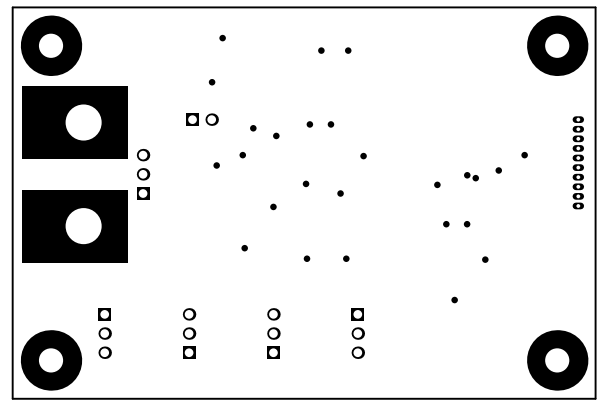
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01608	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01608		
PLOT NAME = Top Solder Mask	GENERATED : 12/15/2017 11:39:57 AM	TEXAS INSTRUMENTS	



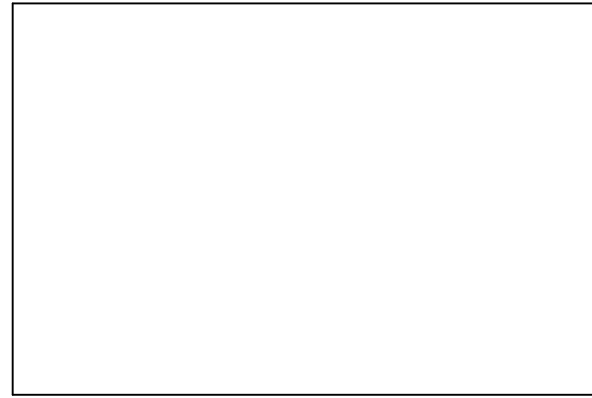
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01608	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01608		
PLOT NAME = Top Layer	GENERATED : 12/15/2017 11:39:58 AM	TEXAS INSTRUMENTS	



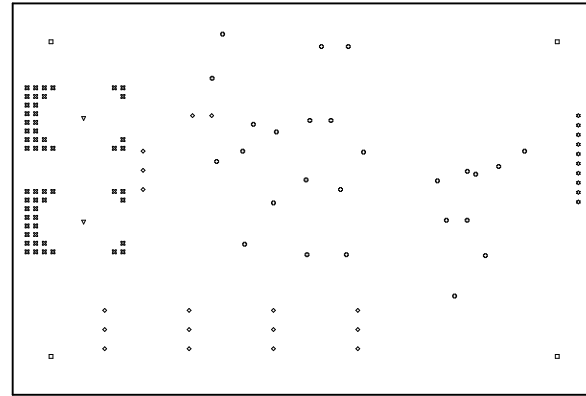
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01608	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01608		
PLOT NAME = Bottom Layer	GENERATED : 12/15/2017 11:39:59 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01608	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01608		
PLOT NAME = Bottom Solder Mask	GENERATED : 12/15/2017 11:39:59 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01608	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01608		
PLOT NAME = Bottom Overlay	GENERATED : 12/15/2017 11:40:00 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
⊙	26	15.00mil (0.381mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	56	16.00mil (0.406mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	10	20.00mil (0.508mm)	PTH	Round	Top Layer - Bottom Layer	
◇	17	45.28mil (1.150mm)	PTH	Round	Top Layer - Bottom Layer	
□	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	
▽	2	188.00mil (4.775mm)	PTH	Round	Top Layer - Bottom Layer	
	115 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01608	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01608		
PLOT NAME = Drill Drawing	GENERATED : 12/15/2017 11:40:01 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01608	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01608		
PLOT NAME = Board Dimensions	GENERATED : 12/15/2017 11:40:03 AM	TEXAS INSTRUMENTS	



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